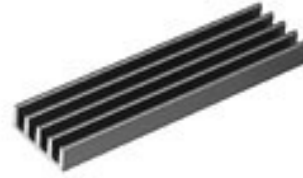


# Board Level Cooling – Extruded 5080



## BOARD LEVEL COOLING – Extruded 5080

Extruded 5080 is a series of rectangular bi-directional board level heat sinks designed to cool DIP 24 and DIP 40 devices. Representative image only.



## ORDERING INFORMATION

Part Number	Device Type
508500B00000G	DIP 24
508700B00000G	DIP 40

## HEAT SINK DETAILS

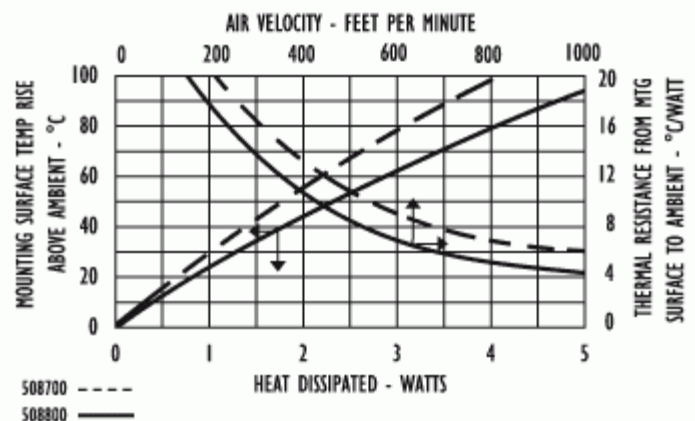
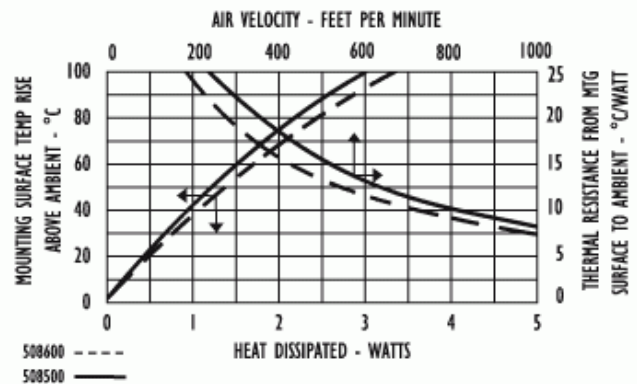
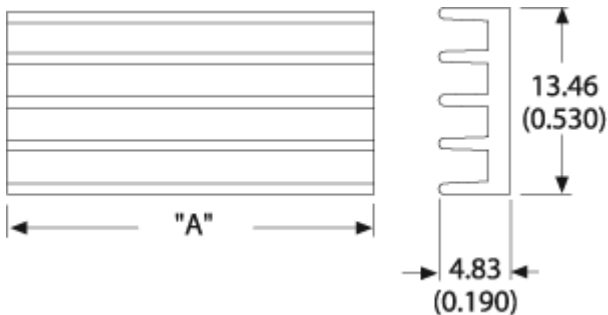
Property	Details
Material	Aluminum
Finish	Black Anodize
Device Attachment Options	Epoxy
Thermal Interface Material	-

Property	Details
Heat Sink Width (mm)	13.46
Heat Sink Length (mm)	See "A" Dim below
Heat Sink Height (mm)	4.83
Heat Sink Mounting Direction	Horizontal

## MECHANICAL & PERFORMANCE

Drawing dimensions are shown in mm, (in)

Part Number	"A" Dim
508500B00000G	31.75
508700B00000G	50.80



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